



Office of the Controller General of Patents, Designs & Trade Marks
 Department for Promotion of Industry and Internal Trade
 Ministry of Commerce & Industry,
 Government of India

(<http://ipindia.nic.in/index.htm>)



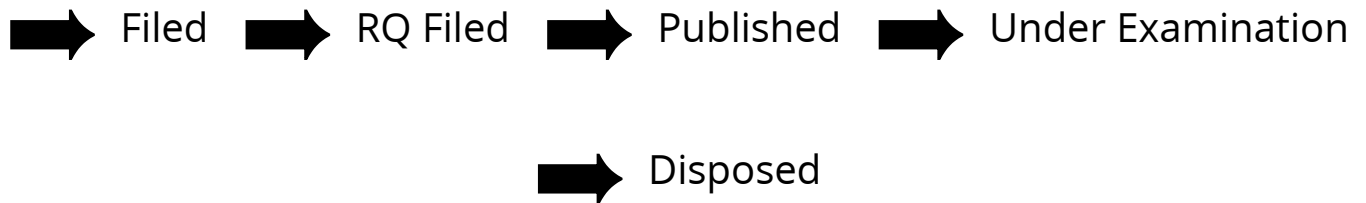
(<http://ipindia.nic.in/index.htm>)

Application Details

APPLICATION NUMBER	201941028296
APPLICATION TYPE	ORDINARY APPLICATION
DATE OF FILING	15/07/2019
APPLICANT NAME	1 . JAYESH S 2 . JACOB ELIAS
TITLE OF INVENTION	LEAD FREE SOLDER ALLOY FOR MODERATELY HIGH TEMPERATURE APPLICATIONS
FIELD OF INVENTION	MECHANICAL ENGINEERING
E-MAIL (As Per Record)	
ADDITIONAL-EMAIL (As Per Record)	jayesh.jhe@gmail.com
E-MAIL (UPDATED Online)	patent.tradmark@gmail.com
PRIORITY DATE	
REQUEST FOR EXAMINATION DATE	30/10/2019
PUBLICATION DATE (U/S 11A)	29/11/2019
FIRST EXAMINATION REPORT DATE	27/08/2020
Date Of Certificate Issue	28/07/2022
POST GRANT JOURNAL DATE	05/08/2022
REPLY TO FER DATE	09/12/2020

Application Status

APPLICATION STATUS

**Granted Application, Patent Number
:402398**[E-Register](#)[View Documents](#)

In case of any discrepancy in status, kindly contact ipo-helpdesk@nic.in